

DATASHEET

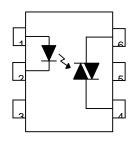
6 PIN DIP RANDOM-PHASE TRIAC DRIVER PHOTOCOUPLER EL301X, EL302X, EL305X Series



Features:

- Peak breakdown voltage
 - 250V: EL301X - 400V: EL302X
- 600V: EL305X
- High isolation voltage between input and output (Viso=5000 V rms)
- Compact dual-in-line package
- Pb free and RoHS compliant.
- UL approved (No. E214129)
- VDE approved (No.132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CSA approved

Schematic



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- 4. Terminal
- Substrate (do not connect)
- 6. Terminal

Description

The EL301X, EL302X and EL305X series of devices each consist of a GaAs infrared emitting diode optically coupled to a monolithic silicon random phase photo Triac.

They are designed for interfacing between electronic controls and power triacs to control resistive and inductive loads for 115 to 240 VAC operations.

Applications

- Solenoid/valve controls
- Lamp ballasts
- Static AC power switch
- Interfacing microprocessors to 115 to 240Vac peripherals
- Incandescent lamp dimmers
- Temperature controls
- Motor controls

R

LifecyclePhase:

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Absolute Maximum Ratings (Ta=25)

	Parameter		Symbol	Rating	Unit	
Input	Forward current		I _F	60	mA V	
	Reverse voltage		V _R	6		
	Power dissipation		П	100	mW	
	Derating factor (above	$T_a = 85^{\circ}C$	P _D -	3.8	mW /°C	
Output		EL301X		250		
	Off-state Output Terminal Voltage	EL302X	V_{DRM}	400	V	
		EL305X		600	-	
	Peak Repetitive Surge (pw=100µs,120pps)	Current	I _{TSM}	1	А	
	On-State RMS Current		I _{T(RMS)}	100	mA	
	Power dissipation		D	300	mW	
	Derating factor (above T _a = 85°C)		P _C -	7.4	mW/	
Total power dissipation			P _{TOT}	330	mW	
Isolation voltage *1			V _{ISO}	5000	Vrms	
Operating temperature			T _{OPR}	-55 to 100		
Storage temperature			T _{STG}	-55 to 125		
Soldering	g Temperature* ²		T _{SOL}	260		

Notes:

^{*1} AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2&3 are shorted together, and pins 4, 5 & 6 are shorted together.

^{*2} For 10 seconds



Electro-Optical Characteristics (Ta=25 unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Forward Voltage	V_{F}	-	1.18	1.5	V	I _F = 10mA
Reverse Leakage current	I_R	-	-	10	μΑ	$V_R = 6V$

Output

Parameter		Symbol	Min.	Тур.*	Max.	Unit	Condition
Peak Blocking C	urrent	I _{DRM}	-	-	100	nA	V_{DRM} = Rated V_{DRM} I_F = 0mA
Peak On-state Voltage		V_{TM}	-	-	2.5	V	I _{TM} =100mA peak, I _F =Rated I _{FT}
Critical Rate of Rise off-state Voltage	EL301X EL302X	_ dv/dt _	-	100	-	V/µs	V_{PEAK} =Rated V_{DRM} , I_{F} =0 (Fig. 8)
	EL305X		1000	-		1	V _{PEAK} =400V, I _F =0 (Fig. 8)

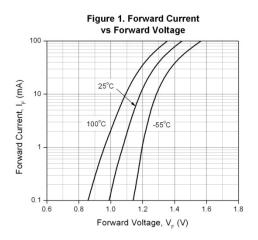
Transfer Characteristics

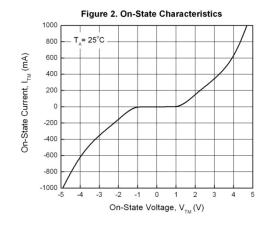
Parameter		Symbol	Min.	Тур.*	Max.	Unit	Condition
	EL3020			A1	30		
	EL3010 EL3021 EL3051				15		
LED Trigger Current	EL3011 EL3022 EL3052	I _{FT}		-	10	mA	Main terminal Voltage=3V
	EL3012 EL3023 EL3053		-	-	5		
Holding Currer	nt	I _H	-	250	-	μΑ	

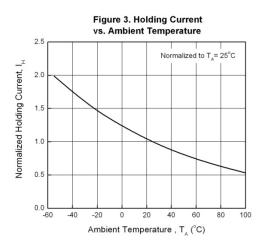
^{*} Typical values at T_a = 25°C

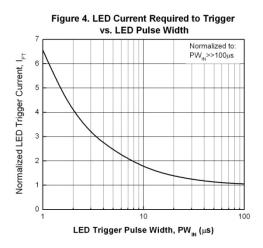


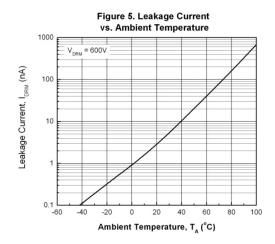
Typical Electro-Optical Characteristics Curves

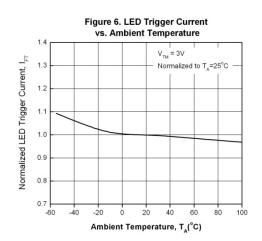












nired Period: Forever

LifecyclePhase:

Approved

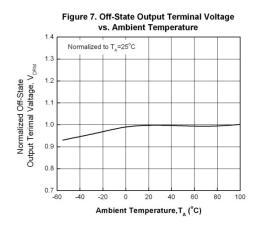
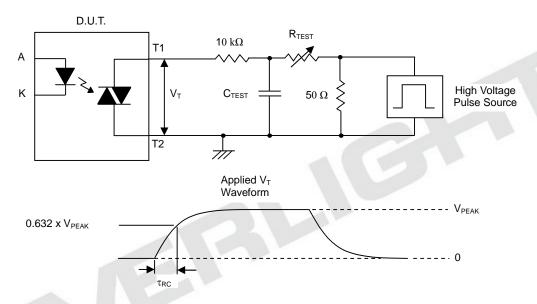


Figure 8. Static dv/dt Test Circuit & Waveform



Measurement Method

The high voltage pulse is set to the required V_{PEAK} value and applied to the D.U.T. output side through the RC circuit above. LED current is not applied. The waveform V_T is monitored using a x100 scope probe. By varying R_{TEST} , the dv/dt (slope) is increased, until the D.U.T. is observed to trigger (waveform collapses). The dv/dt is then decreased until the D.U.T. stops triggering. At this point, τ_{RC} is recorded and the dv/dt calculated.

$$dv/dt = \frac{0.632 \times V_{PEAK}}{\tau_{RC}}$$

For example, $V_{PEAK} = 400V$ for EL302X series. The dv/dt value is calculated as follows:

$$dv/dt = \frac{0.63 \times 400}{\tau_{RC}} = \frac{252}{\tau_{RC}}$$



Order Information

Part Number

EL301XY(Z)-V or EL302XY(Z)-V or EL305XY(Z)-V

Note

X = Part No. for EL301x (0, 1 or 2)

X = Part No. for EL302x, EL305x (1, 2 or 3)

Y = Lead form option (S, S1, M or none)

Z = Tape and reel option (TA, TB or none).

V = VDE safety approved (optional)

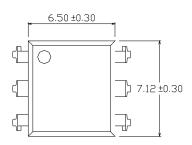
Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
М	Wide lead bend (0.4 inch spacing)	65 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

rired Period: Forever

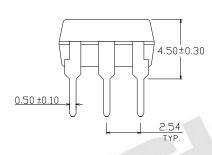


Package Dimension (Dimensions in mm)

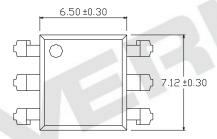
Standard DIP Type

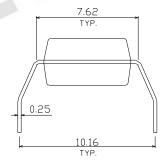


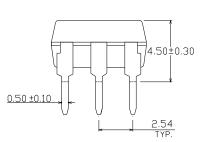




Option M Type

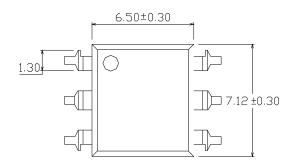


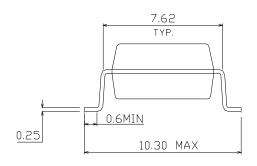


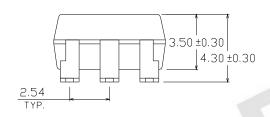




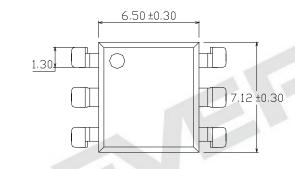
Option S Type

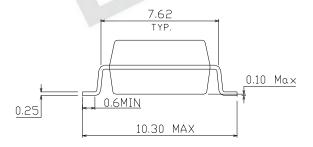


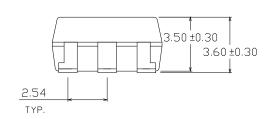




Option S1 Type



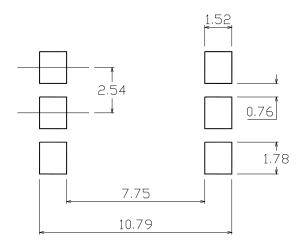




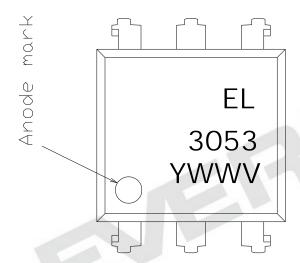
mired Period: Forever



Recommended pad layout for surface mount leadform



Device Marking



Notes

EL denotes EVERLIGHT denotes Device Number 3053 denotes 1 digit Year code WW denotes 2 digit Week code denotes VDE (optional)

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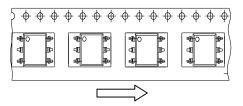
LifecyclePhase:

mired Period: Forever



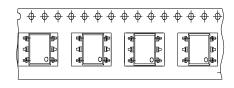
Tape & Reel Packing Specifications

Option TA



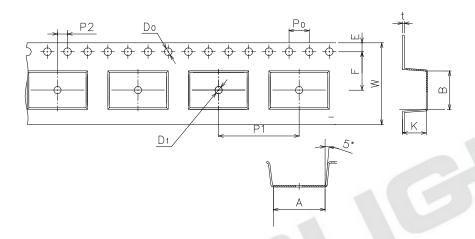
Direction of feed from reel

Option TB



Direction of feed from reel

Tape dimensions



Dimension No.	Α	В	Do	D1	E	F
Dimension (mm)	10.4±0.1	7.5±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1

Dimension No.	Ро	P1	P2	t	w	К
Dimension (mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1

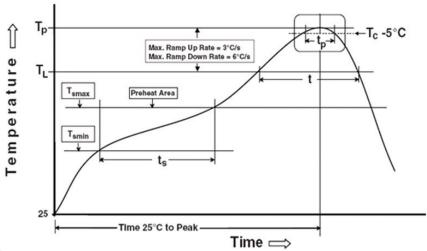
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Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Reference: IPC/JEDEC J-STD-020D

Preheat

150 °C Temperature min (T_{smin}) Temperature max (T_{smax}) 200°C 60-120 seconds Time $(T_{smin} \text{ to } T_{smax}) (t_s)$ Average ramp-up rate $(T_{smax} \text{ to } T_p)$ 3 °C/second max

Other

Liquidus Temperature (T_L) Time above Liquidus Temperature (t L)

Peak Temperature (T_P)

Time within 5 °C of Actual Peak Temperature: T_P - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

217 °C

60-100 sec

260°C

30 s

6°C /second max.

8 minutes max.

3 times



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>>Everlight(亿光)